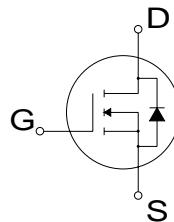
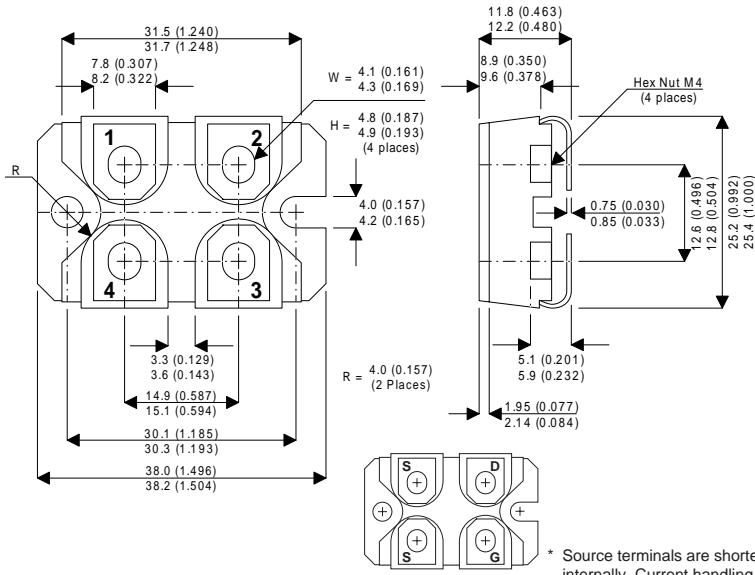


**SEME
LAB**

SML20J122

SOT-227 Package Outline.

Dimensions in mm (inches)



N-CHANNEL ENHANCEMENT MODE HIGH VOLTAGE POWER MOSFETS

V_{DSS} 200V

I_{D(cont)} 112A

R_{DS(on)} 0.019Ω

- Faster Switching
- Lower Leakage
- 100% Avalanche Tested
- Popular SOT-227 Package

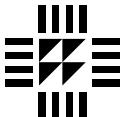
StarMOS is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimises the JFET effect, increases packing density and reduces the on-resistance. StarMOS also achieves faster switching speeds through optimised gate layout.

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

V _{DSS}	Drain – Source Voltage	200	V
I _D	Continuous Drain Current	112	A
I _{DM}	Pulsed Drain Current ¹	448	A
V _{GS}	Gate – Source Voltage	±30	V
V _{GSM}	Gate – Source Voltage Transient	±40	
P _D	Total Power Dissipation @ T _{case} = 25°C	500	W
	Derate Linearly	4	W/°C
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T _L	Lead Temperature : 0.063" from Case for 10 Sec.	300	
I _{AR}	Avalanche Current ¹ (Repetitive and Non-Repetitive)	112	A
E _{AR}	Repetitive Avalanche Energy ¹	30	
E _{AS}	Single Pulse Avalanche Energy ²	1300	mJ

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Starting T_J = 25°C, L = 579μH, R_G = 25Ω, Peak I_L = 112A



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SML20J122

STATIC ELECTRICAL RATINGS ($T_{case} = 25^\circ C$ unless otherwise stated)

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain – Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	200			V
I_{DSS}	Zero Gate Voltage Drain Current ($V_{GS} = 0V$)	$V_{DS} = V_{DSS}$			50	μA
		$V_{DS} = 0.8V_{DSS}, T_C = 125^\circ C$			500	
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$			± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1.0mA$	2		4	V
$I_{D(ON)}$	On State Drain Current ²	$V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max $V_{GS} = 10V$	112			A
$R_{DS(ON)}$	Drain – Source On State Resistance ²	$V_{GS} = 10V, I_D = 0.5 I_D$ [Cont.]			0.019	Ω

DYNAMIC CHARACTERISTICS

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0V$		9700		pF
C_{oss}	Output Capacitance			2250		
C_{rss}	Reverse Transfer Capacitance			680		
Q_g	Total Gate Charge ³	$V_{GS} = 10V$		320		nC
Q_{gs}	Gate – Source Charge			44		
Q_{gd}	Gate – Drain (“Miller”) Charge			155		
$t_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15V$		20		ns
t_r	Rise Time			35		
$t_{d(off)}$	Turn-off Delay Time			55		
t_f	Fall Time			7		

SOURCE – DRAIN DIODE RATINGS AND CHARACTERISTICS

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	(Body Diode)			112	A
I_{SM}	Pulsed Source Current ¹				448	
V_{SD}	Diode Forward Voltage ²	$V_{GS} = 0V, I_S = -I_D$ [Cont.]			1.3	V
t_{rr}	Reverse Recovery Time	$I_S = -I_D$ [Cont.], $dI_S / dt = 100A/\mu s$		340		ns
Q_{rr}	Reverse Recovery Charge	$I_S = -I_D$ [Cont.], $dI_S / dt = 100A/\mu s$			5	μC

THERMAL CHARACTERISTICS

	Characteristic	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction to Case			0.25	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			40	

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Pulse Test: Pulse Width < 380 μs , Duty Cycle < 2%

3) See MIL-STD-750 Method 3471



CAUTION — Electrostatic Sensitive Devices. Anti-Static Procedures Must Be Followed.

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